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1. Definitions. In addition to other terms defined elsewhere in this Agreement, the following terms, when the first letter is capitalized, shall have the meanings set forth below.

1.1 “Affiliate” means: (a) with respect to NXP, NXP B.V. (the parent company of NXP, and a legal entity organized under the laws of the Netherlands) and any corporation or other legal entity that NXP B.V. now or hereafter Controls, and (b) with respect to Licensee, any corporation or other legal entity that Licensee now or hereafter Controls, is Controlled by or is under common Control with; where “**Control**” means the direct or indirect ownership of more than fifty percent (>50%) of the shares or similar interests entitled to vote for the election of directors or other persons performing similar functions. An entity may be considered an Affiliate only when such Control exists.

1.2 “Licensed Materials” mean the software (in object code or source code form) and/or documentation with which this Agreement is provided, and all upgrades, updates and/or information relating thereto that NXP may (in its sole discretion) provide to Licensee under this Agreement.

1.3 “Licensee Platform(s)” means any module or product developed by or for Licensee, which incorporates a NXP Chip and integrates any Redistributable Object Code, for use in Products.

1.4 “Modification(s)” means all derivative works, updates, improvements, enhancements, transformations and modifications of any portion of the Licensed Materials, made by or for Licensee.

1.5 “NXP Chip(s)” means any of the following integrated circuit(s) manufactured by NXP or under license of NXP, which utilize the Licensed Materials: CLRC632, CLRC663, MFRC631, MFRC630, SLRC610, CLRD701, CLRD710, CLRM701, CLRM710, MFRC500, MFRC400, MFRC522, MFRC523, MFRC530, MFRC531, MFRX852, PR601, PRH601, PR533, PN512, PN531, PN532, PN533, PN544, PN547 or equivalent products.

1.6 “Open Source Licensing Terms” means terms in any license for software which require, as a condition of use, modification and/or distribution of such software or other software incorporated into, derived from or distributed with such software (a “**Work**”), any of the following: (a) the making available of source code or design information regarding the Work; (b) the granting of permission for creating derivative works regarding the Work; or (c) the granting of a royalty-free license to any party under intellectual property rights regarding the Work. By means of example and without limitation, Open Source Licensing Terms include the following licenses or distribution models: (i) the GNU General Public License (GPL) or Lesser/Library GPL (LGPL), (ii) the Artistic License (e.g. PERL), (iii) the Mozilla Public License, (iv) the Common Public License, (v) the Sun Community Source License (SCSL), (vi) the Sun Industry Standards Source License (SISSL), and (vii) the Open Software License.

1.7 “Product(s)” means any device made by or for Licensee, or by or for its OEM Customers, which incorporates a Licensee Platform with a NXP Chip.

1.8 “Redistributable Object Code” means any: (a) object code portions of the Licensed Materials provided by NXP to Licensee hereunder, (b) source code portions of the Licensed Materials, provided by NXP to Licensee hereunder, that have been compiled into object code form, and/or (c) Modifications that have been compiled into object code form. For the avoidance of doubt, Redistributable Object Code is solely in object code form.

2. License.

2.1 Source Code License. Subject to the terms and conditions of this Agreement, NXP hereby grants to Licensee a worldwide, non-exclusive, non-transferable, royalty-free license under NXP’s relevant intellectual property rights in the Licensed Materials, without the right to sublicense (except as permitted in Section 2.3), to internally use and create Modifications based upon the source code portions of the Licensed Materials that are provided by NXP to Licensee hereunder, and to compile such source code portions of the Licensed Materials and Modifications into Redistributable Object Code. The Redistributable Object Code may only be used incorporated in, or in conjunction with, the Licensee Platforms incorporating NXP Chips.

2.2 Object Code License. Subject to the terms and conditions of this Agreement, NXP hereby grants to Licensee a worldwide, non-exclusive, non-transferable, royalty-free license under NXP’s relevant intellectual property rights in the Licensed Materials, without the right to sublicense (except as permitted in Sections 2.3 and 2.4), to use, reproduce, create, manufacture, have manufactured, distribute, and have distributed the Redistributable Object Code. The Redistributable Object Code may only be used and distributed incorporated in, or in conjunction with, the Licensee Platforms incorporating NXP Chips, solely for use in Products. No right is granted to Licensee to distribute the Redistributable Object Code as a standalone product.

2.3 Authorized Contractors. Licensee may grant a sublicense, under its license rights granted under Sections 2.1 and 2.2 to a contractor of Licensee (“**Authorized Contractor**”), without the right to further sublicense, solely as necessary for the

development of Licensee's Platforms and/or Licensee's Products; provided, however, that such Authorized Contractor executes a written agreement with Licensee in which such Authorized Contractor has agreed in writing to provisions that substantially provide that the Authorized Contractor shall:

- (a) be bound by obligations of confidentiality at least as restrictive as the confidentiality provisions of this Agreement;
- (b) use the Licensed Materials only on the behalf of Licensee for the development of Licensee's Platforms and/or Licensee's Products; and
- (c) comply with the license restrictions under Section 3.

Licensee shall be liable to NXP for such Authorized Contractor's violations of the confidentiality provisions of this Agreement or the Authorized Contractor's intentional or unintentional misappropriation of or loss of NXP's intellectual property rights or ownership of the Licensed Materials or Modifications.

2.4 OEM Customers. Licensee may grant sublicenses, under its license rights granted under Section 2.2 to original equipment manufacturer customers of Licensee ("**OEM Customers**"), only in respect to the Redistributable Object Code that is incorporated in, or for use in conjunction with, the Licensee Platform and solely for use with NXP Chips in such OEM Customer's Products; provided, however, that such Redistributable Object Code is subject to a written software license agreement, in the form that Licensee normally uses for protecting its own software of like nature, executed by such OEM Customer and Licensee, which shall include at a minimum provisions that materially provide:

- (a) that such Redistributable Object Code is to be used only for the development of the OEM Customer's Products;
- (b) that such Redistributable Object Code may be distributed only in Products with NXP Chips;
- (c) that the OEM Customer will comply with the license restrictions under Section 3; and
- (d) that such Redistributable Object Code shall be protected as the confidential information of NXP under obligations of confidentiality no less restrictive than the confidentiality provisions of this Agreement.

2.5 End User's Right to use the Redistributable Object Code. The rights granted hereunder include the right for any end user to personally use the Redistributable Object Code as integrated in a Product with a NXP Chip, and that such right of use shall survive any expiration or termination of this Agreement.

3. License Restrictions. The license granted in Section 2 does not include any license, right, power or authority to cause the Licensed Materials or Modifications, in whole or in part, to be subject to Open Source Licensing Terms. Licensee shall not, and shall not permit any third party to (i) reverse engineer, decompile or disassemble any object code portions of the Licensed Materials, (ii) remove or alter any proprietary markings or notices from the Licensed Materials, or (iii) otherwise use any portion of the Licensed Materials or Modifications in any manner not expressly authorized in Section 2.

4. Confidentiality. The Licensed Materials include confidential and proprietary information and materials and may include trade secrets. Licensee agrees to use the Licensed Materials only for the purposes expressly permitted under this Agreement. Licensee agrees to maintain the confidentiality of the Licensed Materials by not disclosing the Licensed Materials to any third parties, except to the extent expressly permitted under this Agreement, provided that the recipient shall be subject to nondisclosure agreements at least as restrictive as the confidentiality provisions of this Agreement. Licensee agrees to use at least the same physical and other security measures for the Licensed Materials as Licensee uses for its own highly confidential information and documentation, however, in no event less than a reasonable degree of care. Licensee agrees that it shall be responsible for violations of this obligation by its employees, contractors and/or any third party receiving such Licensed Materials from Licensee. Licensee agrees to notify NXP promptly in the event of circumstances in which it would appear that any portion of the Licensed Materials have been prejudiced or exposed to loss or disclosure, and Licensee shall, upon NXP's request, take reasonable steps necessary to recover any such compromised Licensed Materials. The cost of taking such reasonable steps shall be borne solely by Licensee. Notwithstanding the above, this Section 4 does not apply to Redistributable Object Code.

5. Ownership; Reservation of Rights. This Agreement does not transfer any ownership interest in the Licensed Materials. Except for those rights specifically granted in Section 2: (i) NXP, its Affiliates and their suppliers reserve all right, title and interest in and to the Licensed Materials and Modifications, and (ii) no other express or implied license, right or interest in any patent, patent application, copyright, trade secret, trademark or any other intellectual property right are granted hereunder. Licensee agrees to promptly deliver to NXP each Modification created. Licensee hereby irrevocably and unconditionally assigns and otherwise transfers to NXP, and agrees to subsequently assign and otherwise transfer to NXP from time to time as they accrue, Licensee's entire right, title and interest in and to each Modification.

6. Term; Termination; Effects. This Agreement shall commence on the date that Licensee accepts this Agreement (by Licensee indicating its acceptance of this Agreement or by Licensee installing or using the Licensed Materials) and shall remain in effect until terminated as provided in this Section 6 (the "**Term**"). Licensee may terminate this Agreement, at any time for any or no reason. This Agreement will automatically terminate if Licensee fails to comply with any of the terms of this Agreement. Upon any termination of this Agreement: (i) all rights and licenses granted to Licensee under this Agreement shall immediately terminate; (ii) Licensee shall promptly return to NXP or, at NXP's discretion, destroy all of the Licensed Materials, Modifications and all whole and partial copies thereof (including without limitation all Redistributable Object Code); (iii) within thirty (30) days after such termination, Licensee shall furnish to NXP a written certification that all of the Licensed Materials,

Modifications and all whole and partial copies thereof, have been (a) destroyed or returned to NXP, and (b) erased from all of Licensee's storage elements and devices; and (iv) Licensee shall not keep any archival copies of the Licensed Materials or Modifications except and only to the extent that applicable law notwithstanding this limitation expressly permits such. All defined terms, Section 2.5 and Sections 3 through 12 shall survive any termination of this Agreement. In addition, any termination of this Agreement shall not affect the rights of Licensee's customers regarding Redistributable Object Code properly furnished to such customers before such termination.

7. Remedies. Licensee acknowledges and agrees that, if NXP is required to bring an action to enforce the provisions of this Agreement, the damages may be irreparable and difficult to measure and NXP shall be entitled to seek equitable relief including a preliminary injunction in addition to any other relief available. Licensee agrees that in the event that NXP seeks an injunction hereunder, Licensee hereby waives any requirement for the posting of a bond or any other security.

8. Disclaimer. THE LICENSED MATERIALS ARE PROVIDED ON AN "AS IS" AND "WITH ALL FAULTS" BASIS. NXP, ITS AFFILIATES AND THEIR SUPPLIERS EXPRESSLY DISCLAIM ALL WARRANTIES, WHETHER EXPRESS, IMPLIED OR STATUTORY, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF NON-INFRINGEMENT, MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE. THE ENTIRE RISK AS TO THE QUALITY, OR ARISING OUT OF THE USE OR PERFORMANCE, OF THE LICENSED MATERIALS REMAINS WITH LICENSEE.

9. Limitation of Liability. IN NO EVENT SHALL NXP, ITS AFFILIATES OR THEIR SUPPLIERS BE LIABLE TO LICENSEE FOR ANY SPECIAL, INDIRECT, CONSEQUENTIAL, PUNITIVE, OR INCIDENTAL DAMAGES (INCLUDING WITHOUT LIMITATION DAMAGES FOR LOSS OF BUSINESS, BUSINESS INTERRUPTION, LOSS OF USE, LOSS OF DATA OR INFORMATION, AND THE LIKE) ARISING OUT OF THIS AGREEMENT OR THE USE OF OR INABILITY TO USE THE LICENSED MATERIALS, WHETHER OR NOT BASED ON TORT (INCLUDING NEGLIGENCE), STRICT LIABILITY, BREACH OF CONTRACT, BREACH OF WARRANTY OR ANY OTHER THEORY, EVEN IF ADVISED OF THE POSSIBILITY OF SUCH DAMAGES. NOTWITHSTANDING ANY DAMAGES THAT LICENSEE MIGHT INCUR FOR ANY REASON WHATSOEVER (INCLUDING, WITHOUT LIMITATION, ALL DAMAGES REFERENCED ABOVE AND ALL DIRECT OR GENERAL DAMAGES), THE ENTIRE LIABILITY OF NXP, ITS AFFILIATES AND THEIR SUPPLIERS UNDER ANY PROVISION OF THIS AGREEMENT AND LICENSEE'S EXCLUSIVE REMEDY FOR ALL OF THE FOREGOING SHALL BE LIMITED TO ACTUAL DAMAGES INCURRED BY LICENSEE BASED ON REASONABLE RELIANCE UP TO THE GREATER OF THE AMOUNT ACTUALLY PAID BY LICENSEE UNDER THIS AGREEMENT OR FIVE U.S. DOLLARS (U.S. \$5.00). THE FOREGOING LIMITATIONS, EXCLUSIONS AND DISCLAIMERS SHALL APPLY TO THE MAXIMUM EXTENT PERMITTED BY APPLICABLE LAW, EVEN IF ANY REMEDY FAILS OF ITS ESSENTIAL PURPOSE.

10. NXP Contracting Entity; Governing Law; Jurisdiction. The NXP contracting entity, governing law and jurisdiction for this Agreement are determined by the country/region in which Licensee received the Licensed Materials, as detailed below.

10.1 AMERICAS. If Licensee received the Licensed Materials in the AMERICAS (as defined below) then:

(a) the NXP contracting entity is: **NXP Semiconductors USA, Inc.**, a Delaware corporation, having a place of business at 411 East Plumeria Drive, San Jose, CA 95134, U.S.A.

and

(b) this Agreement shall be governed by and construed in accordance with the laws of the State of California without regard to any principle of conflicts of law. Any dispute arising hereunder shall be resolved in the state or federal courts located in the Northern District of California, and the Parties hereby agree that venue and jurisdiction for any related proceedings arising hereunder shall lie exclusively with such courts; provided, however, that each Party may enforce its and its Affiliates' intellectual property rights in any court, and similar governing body, of competent jurisdiction, including but not limited to equitable relief.

As used above, "**AMERICAS**" means any jurisdiction (subject to the restrictions of Section 11 below) within North America, South America or their surrounding territories, including without limitation the following countries/regions: Anguilla, Antigua and Barbuda, Argentina, Aruba, Bahamas, Barbados, Belize, Bermuda, Bolivia, Brazil, Canada, Cayman Islands, Chile, Colombia, Costa Rica, Curacao, Dominica, Dominican Republic, Ecuador, El Salvador, French Guiana, Grenada, Guam, Guatemala, Guyana, Haiti, Honduras, Jamaica, Martinique, Mexico, Montserrat, Netherlands Antilles, Nicaragua, Panama, Paraguay, Peru, Puerto Rico, Saint Kitts and Nevis, Saint Lucia, Saint Pierre and Miquelon, Saint Vincent and The Grenadines, Suriname, Trinidad and Tobago, Turks and Caicos Islands, United States, Uruguay, Venezuela, Virgin Islands (British) and Virgin Islands (U.S.).

10.2 EMEA. If Licensee received the Licensed Materials in the EMEA (as defined below) then:

(a) the NXP contracting entity is: **NXP Semiconductors Netherlands B.V.**, a Dutch corporation, having a place of business at High Tech Campus 60, 5656 AG Eindhoven, The Netherlands.

and

(b) this Agreement shall be governed by and construed in accordance with the laws of The Netherlands without regard to any principle of conflicts of law. Any dispute arising hereunder shall be resolved in the competent courts in Amsterdam, The Netherlands, and the Parties hereby agree that venue and jurisdiction for any related proceedings arising hereunder shall lie

exclusively with such courts; provided, however, that each Party may enforce its and its Affiliates' intellectual property rights in any court, and similar governing body, of competent jurisdiction, including but not limited to equitable relief.

As used above, "**EMEA**" means any jurisdiction (subject to the restrictions of Section 11 below) within Europe, the Middle East, Africa or their surrounding territories, including without limitation the following countries/regions: Afghanistan, Albania, Algeria, Andorra, Angola, Armenia, Austria, Azerbaijan, Bahrain, Belarus, Belgium, Benin, Bosnia and Herzegovina, Botswana, Bouvet Island, Bulgaria, Burkina Faso, Burundi, Cameroon, Central African Republic, Chad, Comoros, Congo, Cote d'Ivoire, Croatia, Cyprus, Czech Republic, Democratic Republic of Sao Tome and Principe, Denmark, Djibouti, Egypt, Estonia, Ethiopia, Faeroe Islands, Finland, France, Gabon, Gambia, Georgia, Germany, Ghana, Gibraltar, Greece, Greenland, Guadeloupe, Guinea-Bissau, Hungary, Iceland, Ireland, Israel, Italy, Jordan, Kazakhstan, Kenya, Kosovo, Kuwait, Kyrgyzstan, Latvia, Lebanon, Lesotho, Liberia, Liechtenstein, Lithuania, Luxembourg, Macedonia, Madagascar, Malawi, Mali, Malta, Mauritania, Mauritius, Moldova, Monaco, Mongolia, Morocco, Mozambique, Namibia, Netherlands, New Caledonia, Niger, Nigeria, Norway, Oman, Pakistan, Poland, Portugal, Qatar, Republic of Cape Verde, Republic of Equatorial Guinea, Republic of Guinea, Republic of Senegal, Reunion, Romania, Russian Federation, Rwandese Republic, Saint Helena, San Marino, Saudi Arabia, Seychelles, Sierra Leone, Slovakia, Slovenia, Somalia, South Africa, Spain, Svalbard and Jan Mayen, Swaziland, Sweden, Switzerland, Tajikistan, Tanzania, Togo, Tunisia, Turkey, Turkmenistan, Uganda, Ukraine, United Arab Emirates, United Kingdom, Uzbekistan, Vatican City State, Yemen, Zaire, Zambia and Zimbabwe.

10.3 ASIA-PACIFIC. If Licensee received the Licensed Materials in the ASIA-PACIFIC (as defined below) then:

(a) the NXP contracting entity is: **NXP Semiconductors Singapore Pte. Ltd.**, a Singapore corporation, having a place of business at 620A Lorong 1 Toa Payoh, Singapore 319762.

and

(b) this Agreement shall be governed by and construed in accordance with the laws of Singapore without regard to any principle of conflicts of law. Any dispute arising hereunder shall be resolved in the competent courts in Singapore, and the Parties hereby agree that venue and jurisdiction for any related proceedings arising hereunder shall lie exclusively with such courts; provided, however, that each Party may enforce its and its Affiliates' intellectual property rights in any court, and similar governing body, of competent jurisdiction, including but not limited to equitable relief.

As used above, "**ASIA-PACIFIC**" means any jurisdiction (subject to the restrictions of Section 11 below) generally considered as part of the Asia-Pacific region (and not part of the Americas or EMEA) including without limitation the following countries/regions: American Samoa, Australia and its external territories, Bangladesh, Bhutan, Brunei Darussalam, Cambodia, Cook Islands, East Timor, Fiji, French Polynesia, French Southern Territories, Hong Kong, India, Indonesia, Japan, Kiribati, Lao Peoples Democratic Republic, Macao, Malaysia, Maldives, Marshall Islands, Mayotte, Micronesia, Nauru, Nepal, New Zealand, Niue, Northern Mariana Islands, Palau, Papua New Guinea, People's Republic of China, Philippines; Pitcairn, Republic of Korea, Samoa, Singapore, Solomon Islands, Sri Lanka, Taiwan, Thailand, Tokelau, Tonga, Tuvalu, Wallis and Futuna Islands, Vanuatu and Vietnam.

11. Export Laws. Insofar as these relate to the activities under this Agreement, Licensee shall comply with all applicable national and international export control laws and regulations. In particular, Licensee shall not directly or indirectly export, re-export, transfer or release any Licensed Materials or direct product thereof to any destination, person, entity or end use restricted or prohibited by applicable laws, without obtaining prior authorization from the applicable competent government authorities to the extent required by those laws.

12. Miscellaneous. (A) Nothing in this Agreement shall create a joint venture, partnership or principal/agent relationship between the Parties. (B) Licensee shall not assign or transfer any of its rights or obligations hereunder without the prior written consent of NXP. Subject to the foregoing, this Agreement shall be binding upon and inure to the benefit of the Parties and their respective successors and permitted assigns. Any attempted assignment other than in strict compliance with this Section 12(B) shall be void. (C) All notices to NXP required or permitted hereunder shall be in writing and shall be deemed delivered upon hand delivery or upon receipt if sent by world renowned overnight courier or mailed by registered or certified mail, return receipt requested, postage prepaid, to NXP at its address set forth in Section 10 or such other address of which NXP may notify Licensee from time to time. (D) A waiver of any right hereunder shall in no way waive any other rights. No waiver, alteration, modification or amendment of this Agreement shall be effective unless in writing and signed by both Parties. (E) In the event that any provision of this Agreement is held to be invalid, illegal or unenforceable, such provision shall be deemed amended to achieve the economic effect of the intent of the Parties in a valid, lawful and enforceable manner, or if not possible, then deleted and ineffective to the extent thereof, without affecting any other provision of this Agreement. (F) This Agreement constitutes the entire agreement regarding the subject matter hereof and supersedes all prior agreements, understandings and communications, oral and written, between the Parties regarding the subject matter hereof.